

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Kamini Jagtiani</td> <td>11/30/2012</td> </tr> <tr> <td>Siew Sim-Tang</td> <td>12/01/2012</td> </tr> <tr> <td>Yang Sun</td> <td>11/30/2012</td> </tr> <tr> <td>Gangavara-Prasad Varakur</td> <td>11/30/2012</td> </tr> </tbody> </table>		Name	Execution Date	Kamini Jagtiani	11/30/2012	Siew Sim-Tang	12/01/2012	Yang Sun	11/30/2012	Gangavara-Prasad Varakur	11/30/2012
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Siew Sim-Tang	12/01/2012										
Yang Sun	11/30/2012										
Gangavara-Prasad Varakur	11/30/2012										
RECEIVING PARTY DATA											
Name:	FutureWei Technologies, Inc.										
Street Address:	5340 Legacy Drive										
Internal Address:	Suite 175										
City:	Plano										
State/Country:	TEXAS										
Postal Code:	75024										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13691402</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13691402						
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Application Number:	13691402										
CORRESPONDENCE DATA											
Fax Number:	9727329218										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
Phone:	(972)732-1001										
Email:	docketing@slater-matsil.com										
Correspondent Name:	Slater & Matsil, L.L.P.										
Address Line 1:	17950 Preston Road										
Address Line 2:	Suite 1000										
Address Line 4:	Dallas, TEXAS 75252										
ATTORNEY DOCKET NUMBER:	HW 83571742US01										
NAME OF SUBMITTER:	Claudette Hoffmann										
Total Attachments: 2 source=HW 83571742US01 Signed Assignment#page1.tif source=HW 83571742US01 Signed Assignment#page2.tif											

CH \$40.00 13691402

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made; and





WHEREAS, FutureWei Technologies, Inc. ("FutureWei"), a corporation organized and existing under the laws of Texas, with its principal office at 5340 Legacy Drive, Suite 175, Plano, TX 75024, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said FutureWei, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said FutureWei, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to FutureWei, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said FutureWei, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said FutureWei, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	Method for Automated Scaling of a Massive Parallel Processing (MPP) Database			
SIGNATURE OF INVENTOR AND NAME	 Kamini Jagtiani	 Siew Sim-Tang	 Yang Sun	 Gangavara-Prasad Varakur
DATE	11/30/2012		11/30/2012	11/30/2012
RESIDENCE (City, State)	Sunnyvale, CA	Saratoga, CA	Palo Alto, CA	Danville, CA

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DATE		12-1-12		
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